Electronic Patent Application Fee Transmittal							
Application Number:	10663304						
Filing Date:	16-Sep-2003						
Title of Invention:	Method of fabricating a dual damascene interconnect structure						
First Named Inventor:	Kallol Bera						
Filer:	Alan Michael Taboada						
Attorney Docket Number:	8477/ETCH/DRIE						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:					i		
Patent-Appeals-and-Interference:							
Notice of appeal		1401	1	500	500		
Post-Allowance-and-Post-Issuance:			,				
Extension of Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 1 month with \$0 paid	1251	1	120	120
Miscellaneous:				
	Tota	620		